

14W+14W STEREO AMPLIFIER WITH MUTE & ST-BY

1 FEATURES

- WIDE SUPPLY VOLTAGE RANGE UP TO +20V
- SPLIT SUPPLY
- HIGH OUTPUT POWER 14+14W
 @THD = 10%, R_L= 8Ω, V_S = ±16V
- NO POP AT TURN-ON/OFF
- MUTE (POP FREE)
- STAND-BY FEATURE (LOW Iq)
- SHORT CIRCUIT PROTECTION TO GND
- THERMAL OVERLOAD PROTECTION
- CLIPWATT 11 PACKAGE

2 **DESCRIPTION**

The TDA7269ASA is class AB Dual Audio Power amplifier assembled in the @ Clipwatt 11 package, spe-

Figure 2. Block Diagram

Figure 1. Package

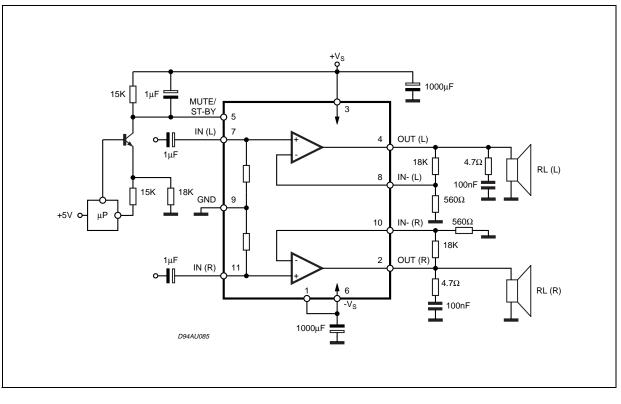


Table 1. Order Codes

Part Number	Package
TDA7269ASA	Clipwatt11

cially designed for high quality sound application as Hi-Fi music centers and stereo TV sets.

The TDA7269ASA is pin to pin compatible with TDA7269, TDA7269A, TDA7269SA, TDA7265, TDA7499, TDA7499SA.



Symbol	Parameter	Value	Unit
VS	DC Supply Voltage	±22	V
lo	Output Power Current (internally limited)	3	А
P _{tot}	Total Power Dissipation (Tamb = 70°C)	20	W
T _{amb}	Ambient Operating Temperature (1)	0 to 70	°C
T _{stg} , T _j	Storage and Junction Temperature	-40 to 150	°C

Table 2. Absolute Maximum Ratings

Figure 3. Pin Connection (Top view)

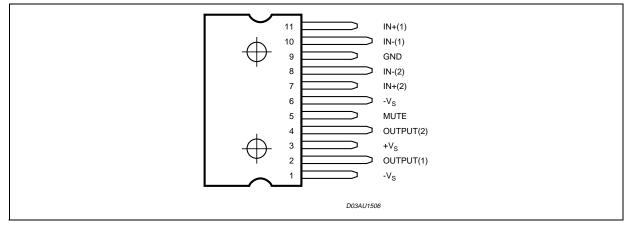


Table 3. Thermal Data

Symbol	Parameter	Value	Unit
R _{th j-case}	Thermal Resistance Junction-case Max.	3.9	°C/W
R _{th j-amb}	Thermal Resistance Junction-ambient	48	°C/W

Figure 4. Single Supply Application

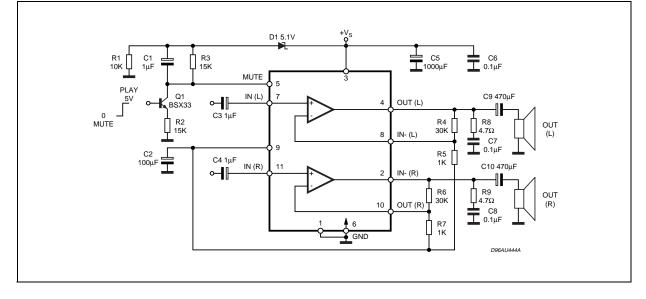


Table 4. ELECTRICAL CHARACTERISTCS

(Refer to the test circuit V_S = ±16V; R_L = 8 Ω ; R_S = 50 Ω ; G_V = 30dB, f = 1KHz; T_{amb} = 25°C, unless otherwise specified)

Symbol	Parameter	Test Condition	Min.	Тур.	Max.	Unit
VS	Supply Voltage Range	$ \begin{array}{l} R_{L} = 8\Omega \\ R_{L} = 4\Omega \end{array} $	±5 ±5		±20 ±15	V V
Ιq	Total Quiescent Current			60	100	mA
V _{OS}	Input Offset Voltage		-25		25	mV
Ib	Non Inverting Input Bias Current			500		nA
Po	Output Power	THD = 10%; $R_L = 8\Omega;$ $V_S = \pm 12.5V; R_L = 4\Omega;$	12 8	14 10		W W
		THD = 1%; $R_L = 8\Omega;$ $V_S = \pm 12.5V; R_L = 4\Omega;$	9 6	11 7.5		W W
THD	Total Harmonic Distortion	$R_L = 8\Omega; P_O = 1W; f = 1KHz;$		0.03		%
		$R_L = 8\Omega; P_O = 0.1 \text{ to } 5W;$ f = 100Hz to 15KHz;			0.7	%
		$R_L = 4\Omega; P_O = 1W; f = 1KHz;$		0.02		%
					1	%
Ст	Cross Talk	f = 1KHz; f = 10KHz;	50	70 60		dB dB
SR	Slew Rate		6.5	10		V/µs
G _{OL}	Open Loop Voltage Gain			80		dB
e _N	Total Output Noise	A Curve f = 20Hz to 22KHz		3 4	8	μV μV
Ri	Input Resistance		15	20		KΩ
SVR	Supply Voltage Rejection (each channel)	f = 100Hz; V _R = 0.5V		60		dB
Тj	Thermal Shut-down Junction Temperature			145		°C
MUTE FU	NCTION [ref +V _S] (*)					
V _{MUTE}	Mute /Play threshold		-7	-6	-5	V
A _{MUTE}	Mute Attenuation		60	70		dB
STAND-B	Y FUNCTIONS [ref: +V _S] (only for	Split Supply)	I			
V _{ST-BY}	Stand-by Mute threshold		-3.5	-2.5	-1.5	V
A _{ST-BY}	Stand-by Attenuation			110		dB
I _{qST-BY}	Quiescent Current @ Stand-by			3	6	mA

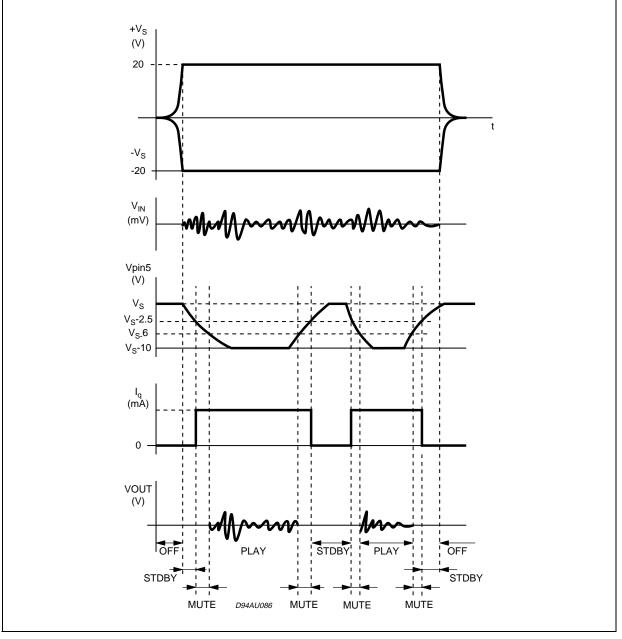
TDA7269ASA

3 MUTE STAND-BY FUNCTION

The pin 5 (MUTE/STAND-BY) controls the amplifier status by two different thresholds, referred to +V_S.

- When V_{pin5} higher than = +V_S -2.5V the amplifier is in Stand-by mode and the final stage generators are off.
- When V_{pin5} between = +V_S -2.5V and V_S -6V the final stage current generators are switched on and the amplifier is in mute mode.
- When V_{pin5} lower than = +V_S -6V the amplifier is play mode.





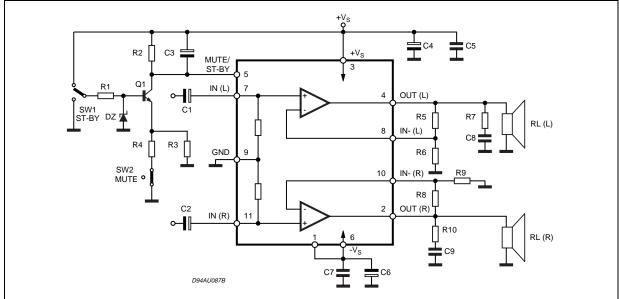


Figure 6. Test and Application Circuit (Stereo Configuration)

4 APPLICATION SUGGESTIONS

4.1 Demo Board Schematic

The recommended values of the external components are those shown the demoboard schematic different values can be used, the following table can help the designer

Table 5. .

COMPONENT	SUGGESTION VALUE	PURPOSE	LARGER THAN RECOMMENDED VALUE	SMALLER THAN RECOMMENDED VALUE	
R1	10KΩ	Mute Circuit	Increase of Dz Biasing Current		
R2	15KΩ	Mute Circuit	V _{pin} #5 Shifted Downward	V _{pin} #5 Shifted Upward	
R3	18KΩ	Mute Circuit	V _{pin} #5 Shifted Upward	V _{pin} #5 Shifted Downward	
R4	15KΩ	Mute Circuit	V _{pin} #5 Shifted Upward	V _{pin} #5 Shifted Downward	
R5, R8	18KΩ	Closed Loop Gain	Increase of Gain		
R6, R9	560Ω	Setting (*)	Decrease of Gain		
R7, R10	4.7Ω	Frequency Stability	Danger of Oscillations	Danger of Oscillations	
C1, C2	1µF	Input DC Decoupling		Higher Low Frequency Cutoff	
C3	1μF	St-By/Mute Time Constant	Larger On/Off Time	Smaller On/Off Time	
C4, C6	1000µF	Supply Voltage Bypass		Danger of Oscillations	
C5, C7	0.1µF	Supply Voltage Bypass		Danger of Oscillations	
C8, C9	0.1µF	Frequency Stability			
Dz	5.1V	Mute Circuit			

(*) Closed loop gain has to be ≥25dB

TDA7269ASA

4.2 PC Board

Figure 7. LC

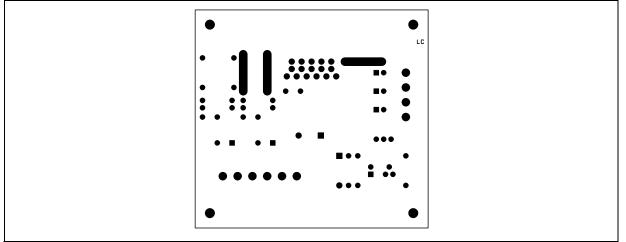


Figure 8. LS

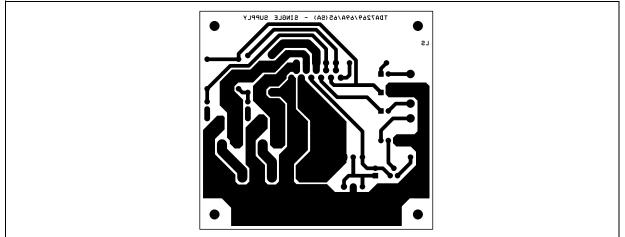
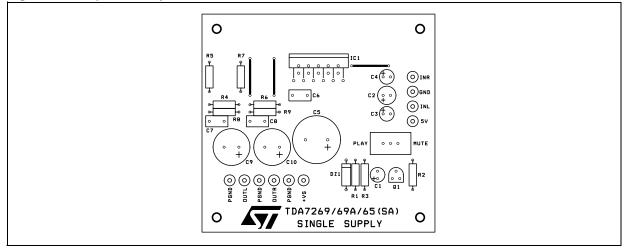


Figure 9. Component Layout



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5 HEAT SINK DIMENSIONING:

In order to avoid the thermal protection intervention, that is placed approximatively at $T_j = 150$ °C, it is important the dimensioning of the Heat Sinker R_{Th} (°C/W).

The parameters that influence the dimensioning are:

- Maximum dissipated power for the device (Pdmax)
- Max thermal resistance Junction to case (RTh j-c)
- Max. ambient temperature Tamb max
- Quiescent current Iq (mA)

5.1 Example:

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 $V_{CC} = \pm 16V$, $R_{load} = 80$ hm, $R_{Th j-c} = 3.9 \text{ °C/W}$, $T_{amb max} = 50$ °C

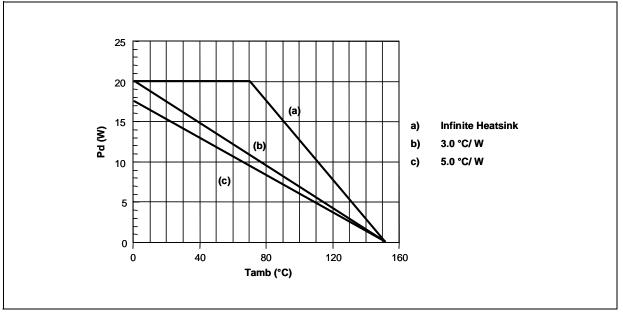
 $P_{dmax} = (N^{\circ} \text{ channels}) \cdot \frac{2V_{cc}^{2}}{\Pi^{2} \cdot R_{load}} + I_{q} \cdot V_{cc}$

 $P_{dmax} = 2 \cdot (6.49) + 0.84 = 14 W$

(Heat Sinker) $R_{Th \ c-a} = \frac{150 - T_{amb \ max}}{P_{d \ max}} - R_{Th \ j-c} = \frac{150 - 50}{14} - 3.9 = 3^{\circ}C/W$

In figure 10 is shown the Power derating curve for the device.

Figure 10. Power derating curve



6 CLIPWATT ASSEMBLING SUGGESTIONS

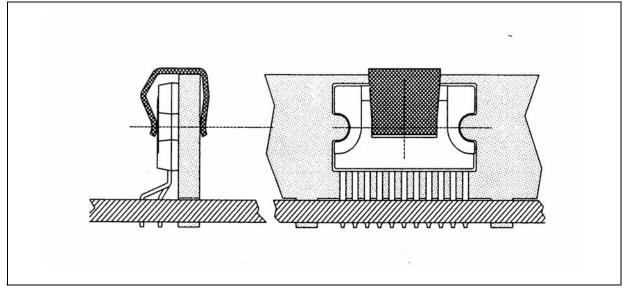
The suggested mounting method of Clipwatt on external heat sink, requires the use of a clip placed as much as possible in the plastic body center, as indicated in the example of figure 11.

A thermal grease can be used in order to reduce the additional thermal resistance of the contact between package and heatsink.

A pressing force of 7 - 10 Kg gives a good contact and the clip must be designed in order to avoid a maximum contact pressure of 15 Kg/mm2 between it and the plastic body case.

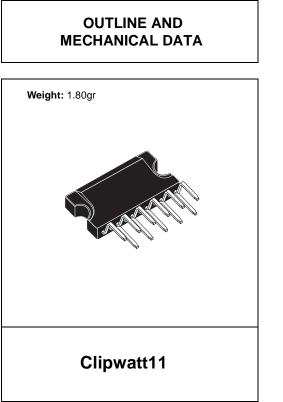
As example , if a 15Kg force is applied by the clip on the package , the clip must have a contact area of 1mm2 at least.

Figure 11. Example of right placement of the clip



DIM.		mm		inch		
Dilvi.	MIN.	TYP.	MAX.	MIN.	TYP.	MAX.
А			3.2			0.126
В			1.05			0.041
С		0.15			0.006	
D		1.5			0.059	
Е	0.49		0.55	0.019		0.002
F	0.77	0.8	0.88	0.030	0.031	0.035
F1			0.15			0.006
G	1.57	1.7	1.83	0.062	0.067	0.072
G1	16.87	17	17.13	0.664	0.669	0.674
H1		12			0.480	
H2		18.6			0.732	
H3	19.85			0.781		
L		17.9			0.700	
L1		14.55			0.580	
L2	10.7	11	11.2	0.421	0.433	0.441
L3		5.5			0.217	
М		2.54			0.100	
M1		2.54			0.100	

Figure 12. Clipwatt11 Mechanical Data & Package Dimensions



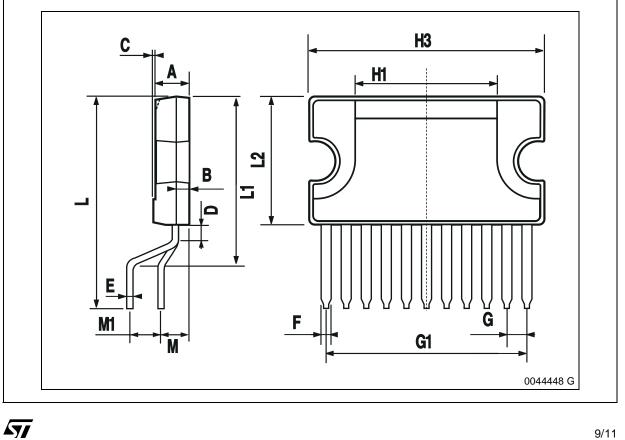


Table 6. Revision History

Date	Revision	Description of Changes
May 2003	1	First Issue
Septembe 2004	2	Changed Status and the graphic aspect in compliant to the new rules "Corporate Technical Pubblications Design Guide"

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